

# Call For Papers

2018 4th International Conference on Applied  
Materials and Manufacturing Technology  
(ICAMMT2018)



Website:  
[www.icammt.net](http://www.icammt.net)

01



Date:  
May 25-27, 2018

02



Venue:  
Nanchang Hangkong  
University

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**Submission Deadline:**  
~~April 15, 2018~~  
**May 20, 2018**

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The 2018 4th International Conference on Applied Materials and Manufacturing Technology will be held in Nanchang, China during May 25-27, 2018. The idea of the conference is for the scientists, scholars, engineers and students from the Universities all around the world and the industry to present ongoing research activities, and hence to foster research relations between the Universities and the industry. It will bring you an unexpected harvest. We welcome you to be a member of ICAMMT 2018.

## Publication

### **IOP** Conference Series Proceedings services for science

All accepted full papers will be published by ***IOP Conference Series: Materials Science and Engineering (MSE)*** (ISSN: 1757-8981) and will be submitted to **EI**, **CPCI** for indexing.

Selected papers will be recommended for publication in SCI journal. ***Mechanics*** (Print ISSN: 1392-1207, Online ISSN: 2029-6983), **IF=0.382** ([Template Download](#))

## Topics

- (1) Composite Materials
- (2) Metal and Its Alloys
- (3) Biomaterials and Environmental Materials
- (4) Thin-Film Materials
- (5) New Functional Materials
- (6) Other topics, [Please click](#)

## Submission

Online Submit: please submit to AEIC Submission System.

E-mail Submit: Please submit to ICAMMT@VIP.163.com.

*1.Papers submitted to the conference should be in English.*

*2.Both Abstract and Full Paper are welcomed. The author can make an oral presentation after the Abstract is accepted and the payment is finished.*

*3.All submitted articles should report original, previously unpublished research results, experimental or theoretical. Articles submitted to the conference should meet these criteria and must not be under consideration for publication elsewhere.*

## Registration

Items	Registration Fee(By US Dollar)
Regular Registration(4-6 pages)	450 USD/per paper
Additional Paper	430 USD/ per paper
★Regular Registration (Groups)	420 USD/per paper (5-10 papers) 400 USD/per paper (≥10 papers)
Extra Pages (Begin at Page 7)	50 USD/Per Extra Paper
Attendees without Papers	180 USD/Per Person
★Attendees without Papers (Groups)	150 USD/Per Person(≥3 Persons)
Purchase Extra Journal	75 USD/book

## Attending

- 1.Author attending: One of the author could attend the symposium for free.
- 2.Keynote Speaker: Applied for keynote speaker Verified by committee .
- 3.Oral Speaker: Applied for oral speaker which limited time is 15 mins.
- 4.Poster: Applied for poster exhibiting which is required side of A1, and color printing.
- 5.Audience: Only be audience, not participate in speech and poster exhibiting.

## Committee

### **Organizer:**

Tongji University, China  
AEIC Academic Exchange Information Centre

### **Conference Chair:**

Prof. Francesca Tittarelli, Università Politecnica delle Marche, Italy

### **Chair of International Technical Committee**

Prof. Peijiang Zhou, Wuhan University, China

### **International Technical Committee:**

Prof. Raju B S, REVA University, India

Dr. Yi Zhang, Chinese Academy of Sciences, China

Dr. M A Gafur M A Gafur, Pilot Plant and Process Development Centre,  
Bangladesh

Mr. PALAKSHA P.A. National Institute of Technology Karnataka, India

Prof. Arnab Kundu, JIS College of Engineering, India

Prof. Francesca Giglio, Mediterranea University of Reggio Calabria, Italy

Prof. Rachana C R, Department of Studies in Computer Science, India

Mr. SANGAMESH RAJOLE, National institute of technology Surathkal, India

Dr. Amitkumar Patel, Charusat Space Research and Technology Center, India

Dr. Azher Jameel, Shri Mata Vaishno Devi University Katra, India

Dr. PAVAN KUMAR THIMMARAJU, Department of Mechanical Engineering,  
NNRG

Dr. A.Senthilrajan, Alagappa University, India

Prof. Nirban Laskar, National Institute of Technology Silchar, Assam, India

Prof. Francesca Tittarelli, Università Politecnica Delle Marche, Italy

Dr. Nirav Pravinchandra Maniar, V. V. P. Engineering College, India

A.Prof. Liu Kuo, Dalian University of Technology, China

Prof. Jin ying Chen, Beijing Polytechnic College, China

Prof. Henry Hu, University of Windsor, Canada

Prof. Tao Zhu, China University of Mining & Technology, China

Prof. Meilinda Nurbanasari, Institut Teknologi Nasional, Bandung, Indonesia

Prof. Binsheng Hu, North China University of Science and Technology, China

## Committee

### International Technical Committee:

Dr. Yi Zhang, Chinese Academy of Sciences, China

A.Prof. Zaiyuzhang, Guizhou University, China

Dr. M A Gafur M A Gafur, Pilot Plant and Process Development Centre, Bangladesh

Sheetal Vilas Mapare, Vidyalkar Institute of Technology, Mumbai, India

Naresh Kumar, Computer Science & Engineering, India

Deepak.D., Manipal Institute of Technology, Manipal University, India

Murthy Cherukuri, National Institute of Science and Technology, India

Xinli Guo, Southeast university, China

Zhangxu Chen, Putian University, China

Fei Yu, Shanghai Institute of Technology, China

Jinhe Wang, Shanghai University, China

Zhenrong Yan, Shanghai Boiler Works Co., Ltd

Qingsheng Wang, Russian St. Petersburg State Polytechnic University, China

Yanhua Zhao, Chongqing University of Arts and Science, China

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Shupeí Cheng, Nanjing University, China

Haozhong Cheng, Shanghai Jiao Tong University, China

Lam Kin Che, The Chinese University of Hongkong, HK

Zhenqian Chen, Southeast University, China

Wenbin Cai, Fudan University, China

Heinz-Gunter, Brokmeier, Technische Universität Clausthal, Germany

Jinglong Bu, Hebei United University, China

Shahrum Abdullah, University Kebangsaan Malaysia, Malaysia

Prof. Shiming Chen, Tongji University, China

Prof. Yeping Wang, Tongji University, China

## Contact

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Dr. Liu WeChat

2018 4th International Conference on Applied  
Materials and Manufacturing Technology  
February 8-10, 2018

